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Part Number: [0442480057](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Inverted, 8/8, 2 Ports

Documents:
[3D Model](#) [Product Specification PS-43860-003 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA	LR19980
UL	E107635

General

Product Family	Modular Jacks/Plugs
Series	44248
Comments	Industry Compatible
Component Type	PCB Jack
Magnetic	No
Overview	modular_plugs_jacks
Performance Category	3
Power over Ethernet (PoE)	N/A
Product Name	RJ45

Physical

Boot Color	N/A
Color - Resin	Black
Durability (mating cycles max)	500
Flammability	94V-0
Inverted / Top Latch	Yes
Lightpipes/LEDs	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Polyester
Orientation	Right Angle (Side Entry)
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.57 mm
Packaging Type	Tray
Panel Mount	With Flange
Pitch - Mating Interface (in)	0.040 In
Pitch - Mating Interface (mm)	1.02 mm
Pitch - Term. Interface (in)	0.040 In
Pitch - Term. Interface (mm)	1.02 mm
Plating min: Mating (µin)	50
Plating min: Mating (µm)	1.25
Plating min: Termination (µin)	100
Plating min: Termination (µm)	2.5
Ports	2
Positions / Loaded Contacts	8/8
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole
Waterproof / Dustproof	No

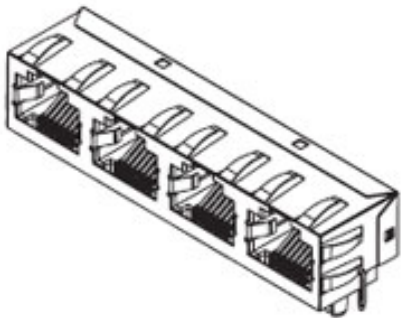


image - Reference only

Series

EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Contains SVHC: No
Halogen-Free
Status

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

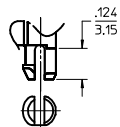
Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
[44248Series](#)

Wire/Cable Type	N/A
Electrical	
Current - Maximum per Contact	1.5A
Grounding to PCB	No
Shielded	No
Voltage - Maximum	150V AC (RMS)
Solder Process Data	
Lead-free Process Capability	Wave Capable (TH only)
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-44248-004
Product Specification	PS-43860-003, RPS-43860-004, RPS-43860-007, RPS-43860-008, RPS-43860-013
Sales Drawing	SD-44248-001

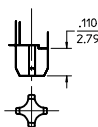
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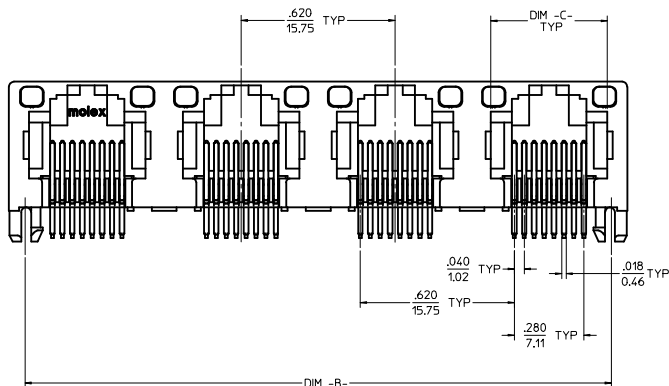
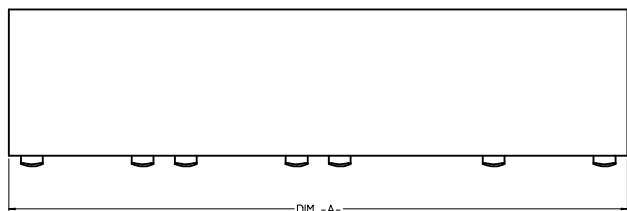
(SNAP-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8

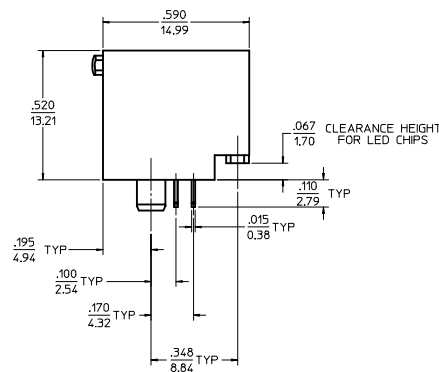


(PRESS-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8



UNSHIELDED
WITH LIGHT PIPES



8 CIRCUIT HOUSING(S)

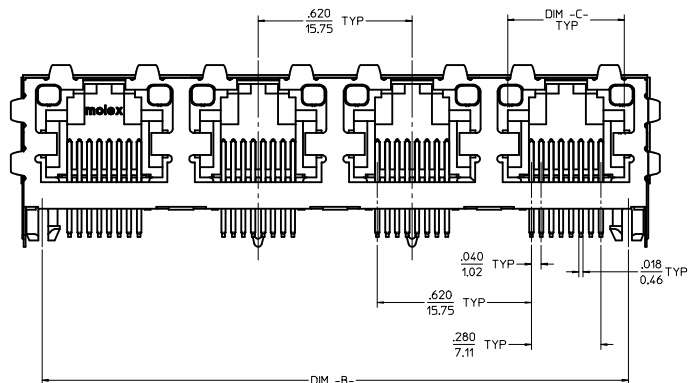
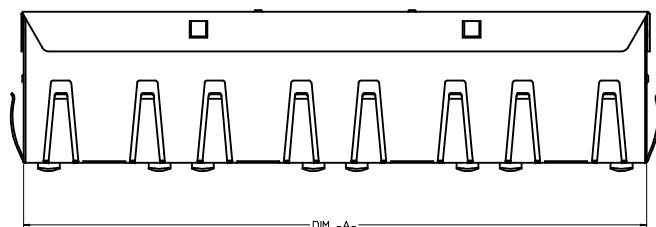
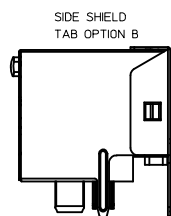
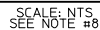
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0001	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0002	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0005	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0006	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0009	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0010	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0011	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0012	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0017	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0018	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0019	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0020	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88

- NOTES:
1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
2) FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
5) APPLICATION SPECIFICATION: AS-43860-001
6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
8) MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
9) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
10) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

CHGD 0117 TO 0119 EC NO.: UCP2009-1482 DRAWN BY: KLOSTNER 2008/12/10 CHKD BY: IELL 2008/12/10 APPR: FSN110	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	TITLE GANGED INVERTED MODJACK ASSEMBLY	
		mm	INCH	DRAWN BY MMAYO	DATE 98/10/06	MOLEX	MOLEX INCORPORATED			
		4 PLACES ±---	±---	CHECKED BY JROBERTS	DATE 98/10/06			DOCUMENT NO. SD-44248-001		SHEET NO. 1 OF 6
		3 PLACES ±---	±.010	APPROVED BY JROBERTS	DATE 98/10/06					
REV C4	DESCRIPTION	2 PLACES ±0.25	±---							
		1 PLACE ±---	±---							
		ANGULAR ±1/2°								
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS								
		SEE CHART								
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



SHIELDED
WITH LIGHT PIPES

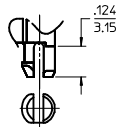
(8) CIRCUIT HOUSING(S)							
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0029	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0030	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
44248-0033	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0034	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92

(6) CIRCUIT HOUSING(S)							
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0037	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0038	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0039	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0040	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0045	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0046	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0047	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0048	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

NOTES:

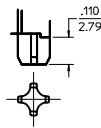
- 1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
- 2) FINISH:
TERMINALS:
• SELECT GOLD IN CONTACT AREA: 50 MICRONS (127 MICROMETERS) MIN.
• SELECT TIN IN PC TAIL AREA: 100 MICRONS (254 MICROMETERS) MIN.
• 100% OVERALL NICKEL UNDERPLATE: 50 MICRONS (127 MICROMETERS) MIN.
SHIELD:
• 100 MICRONS (254 MICROMETERS) NICKEL OVER 50 MICRONS (127 MICROMETERS) COPPER UNDER PLATE
• THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX I OF DIRECTIVE 2000/53/EC"
• PORTIONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.
- 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-A3660-003.
- 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44248-004.
- 5) APPLICATION SPECIFICATION: AS-A3660-001
- 6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- 7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
- 8) MODULAR JACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
- 9) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
- 10) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-A4299-002.

SEE SHEET 1 EC NO: UCT-2009-A482 DRAWN: JADISTENE LER 2008/12/10 CHKD: BELL 2008/12/10 APPR: SMITH 2008/12/10	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
	▽=0 ▽=0	mm	INCH	IN/MM		4:1	INCH		
		4 PLACES ±	±	DRAWN BY	DATE	TITLE			
		3 PLACES ±	±.010	CHECKED BY	DATE	GANGED INVERTED			
		2 PLACES ±	±0.25	JROBERTS	98/10/06	MODJACK ASSEMBLY			
	1 PLACE ±	±	APPROVED BY	DATE					
			JROBERTS	98/10/06	MOLEX MOLEX INCORPORATED				
		ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-44248-001		2 OF 6	
				SIZE D		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			



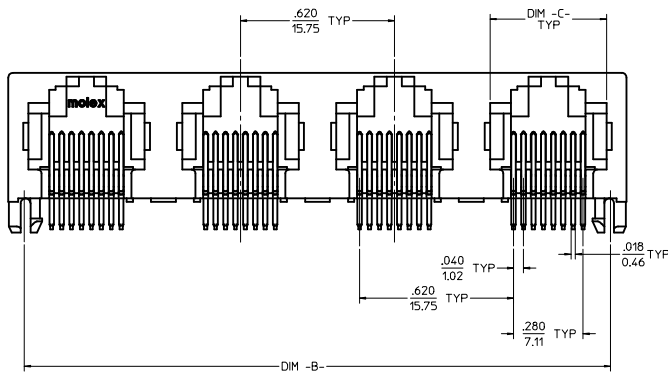
SNAP-FIT PEG OPTION

SCALE: NTS.
SEE NOTE #7



PRESS-FIT PEG OPTION

SCALE: NTS.
SEE NOTE #7



UNSHIELDED

8 CIRCUIT HOUSING(S)

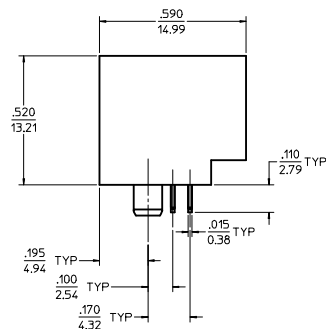
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0057	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0058	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0061	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0062	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

6 CIRCUIT HOUSING(S)

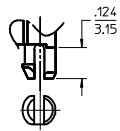
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0065	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0066	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0067	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0068	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0073	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0074	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0075	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0076	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88

NOTES:

- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
- FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
- PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
- PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
- ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
- MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
- PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

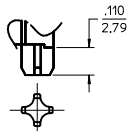


SEE SHEET 1 EC NO: UCP2009-1482 DRAWN: KLOSTERMEIER 2008/12/10 CHKD: IRELL 2008/12/10 APPROVED: SMITH 2008/12/10 C4	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	 THIRD ANGLE PROJECTION
					IN/MM	4:1	INCH		
		▽=0	mm	INCH	DRAWN BY	DATE	TITLE		
		▽=0	4 PLACES ±	±	MMAYO	98/10/06	GANGED INVERTED MODJACK ASSEMBLY		
			3 PLACES ±	±.010	CHECKED BY	DATE			
			2 PLACES ±	±0.25	JROBERTS	98/10/06			
	1 PLACE ±	±	APPROVED BY	DATE	MOLEX INCORPORATED				
		ANGULAR ±1/2°	JROBERTS	98/10/06					
			MATERIAL NO.	DOCUMENT NO.					
			SEE CHART		SD-44248-001		SHEET NO.		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				3 OF 6		
					THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



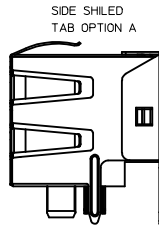
SNAP-FIT PEG OPTION

SCALE: NTS
SEE NOTE #7

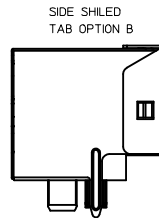


PRESS-FIT PEG OPTION

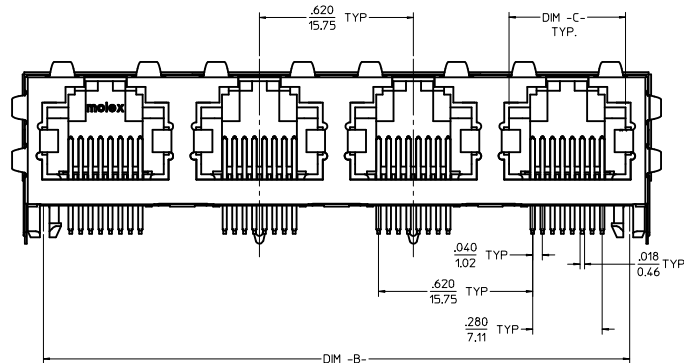
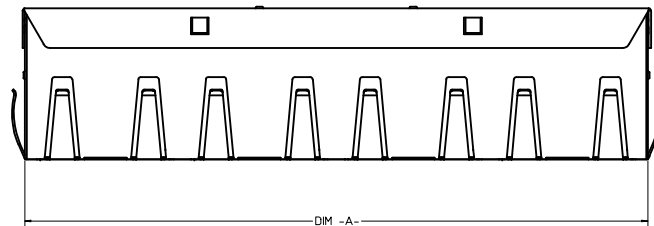
SCALE: NTS
SEE NOTE #7



SIDE SHIELDED
TAB OPTION A

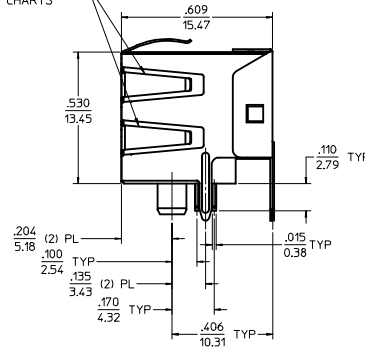


SIDE SHIELDED
TAB OPTION B



SHIELDED

OPTIONAL SIDE
SHIELD TABS
SEE CHARTS



(8) CIRCUIT HOUSING(S)

X = NOT TOOLED	ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
	44248-0085	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0086	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
	44248-0089	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0090	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
X	44248-0119	8	4	PRESS FIT	B	2.514/63.86	2.360/59.94	.469/11.92

(6) CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0093	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0094	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0095	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0096	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0101	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0102	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0103	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0104	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

- NOTES:
- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
 - FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.
SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
SHIELD:
100 MICROINCHES (2.54 MICROMETERS) NICKEL OVER 50 MICROINCHES (1.27 MICROMETERS) COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC"
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.
 - PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44248-004.
 - ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-43499-002.

CHGD 0117 TO 0119 EC NO: UCP2009-1482 DRAWN: KLOS/TEMLER 2008/12/10 CHKD: BEL 2008/12/10 APPROV: SMITH 2008/12/10	QUALITY SYMBOLS =0 =0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
		4 PLACES ±.005 3 PLACES ±.010 2 PLACES ±.025 1 PLACE ±.050		DRAWN BY MMAYO 8/10/06		DATE 8/10/06		
		ANGULAR ±1/2°		APPROVED BY JROBERTS 8/10/06		DATE 8/10/06		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE CHART		DOCUMENT NO. SD-44248-001		
C4				SIZE D		MOLEX INCORPORATED SHEET NO. 4 OF 6		



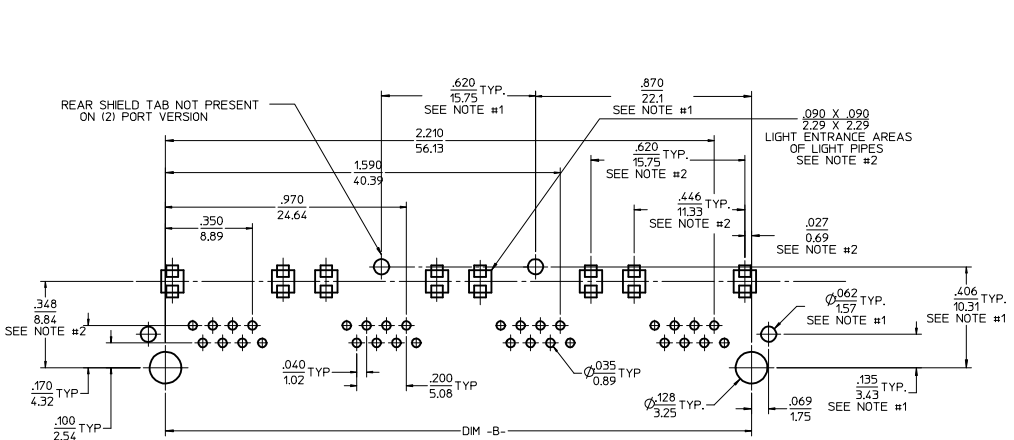
NOTES:

- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH THE SHIELDING OPTION INCLUDED
- 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
- 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

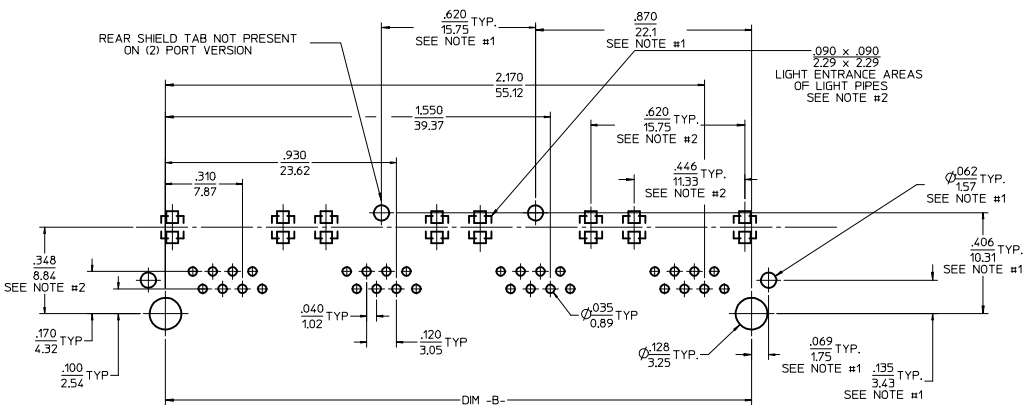
TYPICAL PC TERMINAL HOLE LAYOUT
(8) CIRCUIT CONFIGURATION
SCALE: 10:1

ib_frame_D_P_AM_T
Rev. E 2006/04/15

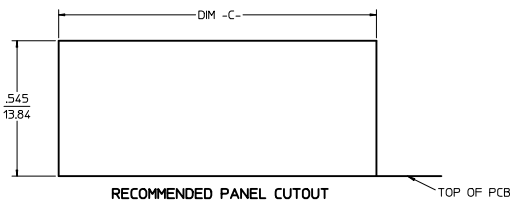
20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1



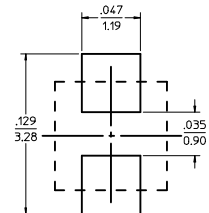
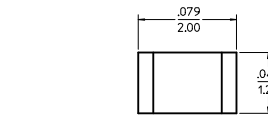
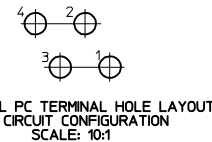
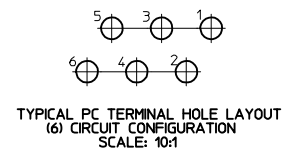
6 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



4 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



NUMBER OF PORTS	DIM -B-	DIM -C-
2	1.120/28.45	1.280/32.51
4	2.360/59.94	2.520/64.01



- NOTES:
- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH SHIELDING OPTION INCLUDED
 - 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
 - 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

SEE SHEET 1 EC. NO.: UCP2009-1482 DRAWING: KLOSTER EER 2008/12/10 CHKD: BELL APPR: FELL 2008/12/10	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION			
				mm INCH	IN/MM	DATE	4:1	INCH	⊙ □	PROJECTION		
			4 PLACES	±---	±---	DRAWN BY	98/10/06	TITLE	GANGED INVERTED MODJACK ASSEMBLY			
			3 PLACES	±---	±.010	CHECKED BY	DATE					
			2 PLACES	±0.25	±---	JROBERTS	98/10/06					
			1 PLACE	±---	±---	APPROVED BY	DATE					
			ANGULAR ±1/2°		JROBERTS	98/10/06						
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.		MOLEX INCORPORATED		SHEET NO.	
					N/A		SD-44248-001		6 OF 6			
					SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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